

B

IFW

FEB 23 2005
PATENT OFFICE

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Bruno GHYSELEN et al.

Confirmation No. 9075

Application No.: 10/637,078

Group Art Unit: 2818

Filing Date: August 6, 2003

Examiner: P. T. Dang

For: METHOD AND APPARATUS FOR
ADJUSTING THE THICKNESS OF A THIN
LAYER OF SEMICONDUCTOR MATERIAL

Atty. Docket No.: 4717-6400

PP

OK

AMENDMENT AFTER ALLOWANCE

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Pursuant to 37 C.F.R. section 1.312(a) and MPEP 714.16, applicants submit the following amendments for entry into the file of this application. In response to the Notice of Allowance received on December 3, 2004, Applicants have reviewed the file and would like to clarify claims 1 and 18. Accordingly, applicants submit the following amendments and remarks for entry into the above-identified application.

Amendments to the Claims are reflected in the listing of claims beginning on page 2 of this paper.

Remarks begin on page 6 of this paper.

No fees are believed to be due for this amendment submission. If there are any required fees, please charge them to Winston & Strawn LLP deposit account no. 50-1814.